



## Material Content Data Sheet



<b>Sales Product Name</b>	TLE4699GM			<b>Issued</b>	25. September 2017			
<b>MA#</b>	MA000970054							
<b>Package</b>	PG-DSO-14-30			<b>Weight*</b>	143.10 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	2.837	1.98	1.98	19823	19823
leadframe	inorganic material	phosphorus	7723-14-0	0.015	0.01		105	
	non noble metal	zinc	7440-66-6	0.060	0.04		422	
	non noble metal	iron	7439-89-6	1.207	0.84		8434	
wire	non noble metal	copper	7440-50-8	49.007	34.25	35.14	342469	351430
	noble metal	gold	7440-57-5	0.192	0.13	0.13	1341	1341
	encapsulation	organic material	carbon black	1333-86-4	0.172	0.12		1204
plastics	plastics	epoxy resin	-	7.925	5.54		55383	
	inorganic material	silicondioxide	60676-86-0	78.046	54.55	60.21	545401	601988
leadfinish	non noble metal	tin	7440-31-5	1.226	0.86	0.86	8569	8569
plating	noble metal	silver	7440-22-4	1.030	0.72	0.72	7196	7196
glue	plastics	acrylic resin	-	0.304	0.21		2124	
	noble metal	silver	7440-22-4	1.077	0.75	0.96	7529	9653
*deviation	< 10%			Sum in total:		100.00		1000000

### Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com